

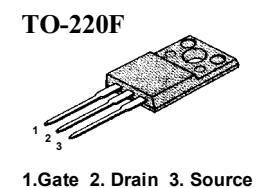
## Advanced Power MOSFET

**SSS4N80A**

### FEATURES

- Avalanche Rugged Technology
- Rugged Gate Oxide Technology
- Lower Input Capacitance
- Improved Gate Charge
- Extended Safe Operating Area
- Lower Leakage Current : 25  $\mu$ A (Max.) @  $V_{DS} = 800V$
- Low  $R_{DS(ON)}$  : 3.400  $\Omega$  (Typ.)

$BV_{DSS} = 800 V$   
 $R_{DS(on)} = 4.0 \Omega$   
 $I_D = 2.5 A$



### Absolute Maximum Ratings

Symbol	Characteristic	Value	Units
$V_{DSS}$	Drain-to-Source Voltage	800	V
$I_D$	Continuous Drain Current ( $T_C=25^\circ C$ )	2.5	A
	Continuous Drain Current ( $T_C=100^\circ C$ )	1.6	
$I_{DM}$	Drain Current-Pulsed ①	16	A
$V_{GS}$	Gate-to-Source Voltage	$\pm 30$	V
$E_{AS}$	Single Pulsed Avalanche Energy ②	250	mJ
$I_{AR}$	Avalanche Current ①	2.5	A
$E_{AR}$	Repetitive Avalanche Energy ①	4	mJ
$dv/dt$	Peak Diode Recovery $dv/dt$ ③	2.0	V/ns
$P_D$	Total Power Dissipation ( $T_C=25^\circ C$ )	40	W
	Linear Derating Factor	0.32	$W/\text{ }^\circ C$
$T_J, T_{STG}$	Operating Junction and Storage Temperature Range	- 55 to + 150	$^\circ C$
$T_L$	Maximum Lead Temp. for Soldering Purposes, 1/8" from case for 5-seconds	300	

### Thermal Resistance

Symbol	Characteristic	Typ.	Max.	Units
$R_{\theta JC}$	Junction-to-Case	--	3.13	$^\circ C/W$
$R_{\theta JA}$	Junction-to-Ambient	--	62.5	

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## Electrical Characteristics ( $T_C=25^\circ\text{C}$ unless otherwise specified)

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
$BV_{DSS}$	Drain-Source Breakdown Voltage	800	--	--	V	$V_{GS}=0\text{V}, I_D=250\mu\text{A}$
$\Delta BV/\Delta T_J$	Breakdown Voltage Temp. Coeff.	--	0.98	--	$^\circ\text{C}$	$I_D=250\mu\text{A}$ See Fig 7
$V_{GS(\text{th})}$	Gate Threshold Voltage	2.0	--	3.5	V	$V_{DS}=5\text{V}, I_D=250\mu\text{A}$
$I_{GSS}$	Gate-Source Leakage , Forward	--	--	100	nA	$V_{GS}=30\text{V}$
	Gate-Source Leakage , Reverse	--	--	-100		$V_{GS}=-30\text{V}$
$I_{DSS}$	Drain-to-Source Leakage Current	--	--	25	$\mu\text{A}$	$V_{DS}=800\text{V}$
		--	--	250		$V_{DS}=640\text{V}, T_C=125^\circ\text{C}$
$R_{DS(\text{on})}$	Static Drain-Source On-State Resistance	--	--	4.0	$\Omega$	$V_{GS}=10\text{V}, I_D=0.85\text{A}$ ④*
$g_f$	Forward Transconductance	--	2.31	--	$\text{O}$	$V_{DS}=50\text{V}, I_D=0.85\text{A}$ ④
$C_{iss}$	Input Capacitance	--	700	910	pF	$V_{GS}=0\text{V}, V_{DS}=25\text{V}, f=1\text{MHz}$ See Fig 5
$C_{oss}$	Output Capacitance	--	65	75		
$C_{rss}$	Reverse Transfer Capacitance	--	25	30		
$t_{d(on)}$	Turn-On Delay Time	--	18	45	ns	$V_{DD}=400\text{V}, I_D=2\text{A}, R_G=16 \Omega$ See Fig 13 ④ ⑤
$t_r$	Rise Time	--	29	70		
$t_{d(off)}$	Turn-Off Delay Time	--	50	110		
$t_f$	Fall Time	--	28	65		
$Q_g$	Total Gate Charge	--	32	42	nC	$V_{DS}=640\text{V}, V_{GS}=10\text{V}, I_D=2\text{A}$ See Fig 6 & Fig 12 ④ ⑤
$Q_{gs}$	Gate-Source Charge	--	6.2	--		
$Q_{gd}$	Gate-Drain("Miller") Charge	--	13.9	--		

## Source-Drain Diode Ratings and Characteristics

Symbol	Characteristic	Min.	Typ.	Max.	Units	Test Condition
$I_s$	Continuous Source Current	--	--	2.5	A	Integral reverse pn-diode in the MOSFET
$I_{SM}$	Pulsed-Source Current ①	--	--	16		
$V_{SD}$	Diode Forward Voltage ④	--	--	1.4	V	$T_J=25^\circ\text{C}, I_S=2.5\text{A}, V_{GS}=0\text{V}$
$t_{rr}$	Reverse Recovery Time	--	380	--	ns	$T_J=25^\circ\text{C}, I_F=4\text{A}$ $dI_F/dt=100\text{A}/\mu\text{s}$ ④
$Q_{rr}$	Reverse Recovery Charge	--	2.89	--		

### Notes :

① Repetitive Rating : Pulse Width Limited by Maximum Junction Temperature

②  $L=75\text{mH}, I_{AS}=2.5\text{A}, V_{DD}=50\text{V}, R_G=27\Omega$ , Starting  $T_J=25^\circ\text{C}$

③  $I_{SD}\leq 4\text{A}, di/dt\leq 110\text{A}/\mu\text{s}, V_{DD}\leq BV_{DSS}$ , Starting  $T_J=25^\circ\text{C}$

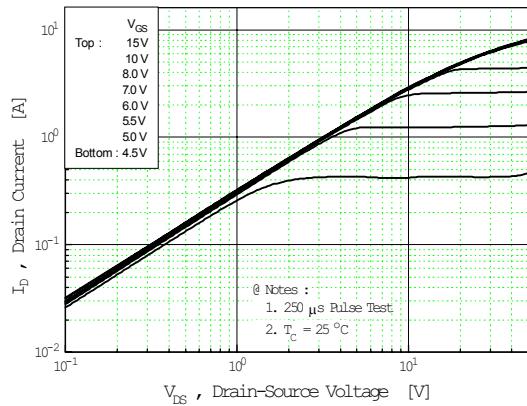
④ Pulse Test : Pulse Width =  $250\mu\text{s}$ , Duty Cycle  $\leq 2\%$

⑤ Essentially Independent of Operating Temperature

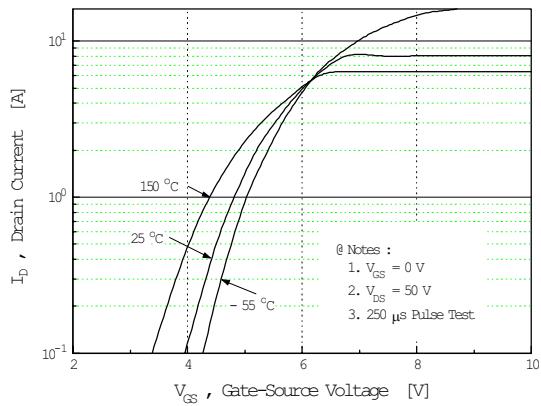
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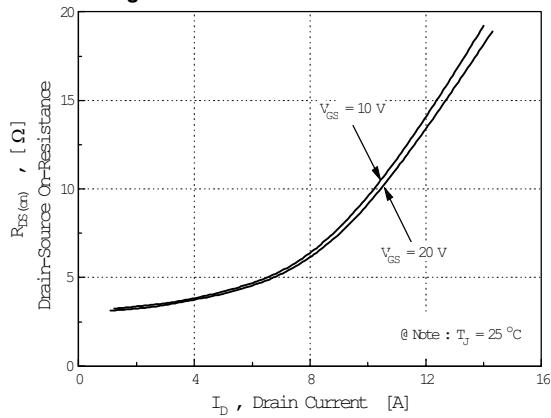
**Fig 1. Output Characteristics**



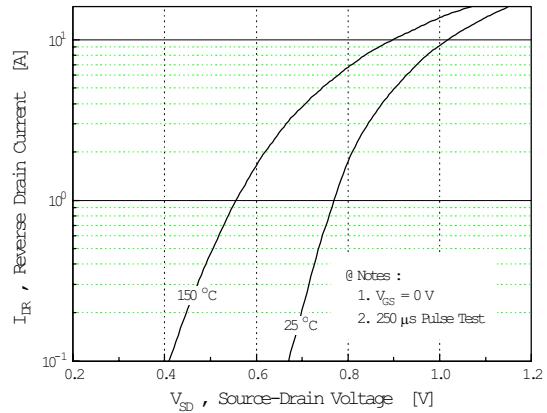
**Fig 2. Transfer Characteristics**



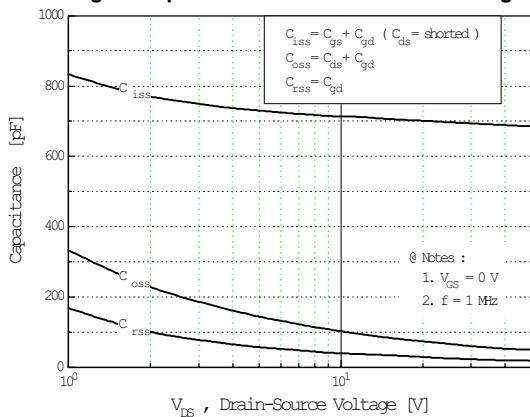
**Fig 3. On-Resistance vs. Drain Current**



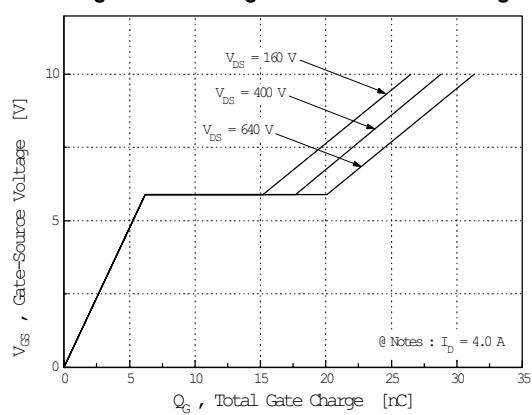
**Fig 4. Source-Drain Diode Forward Voltage**



**Fig 5. Capacitance vs. Drain-Source Voltage**

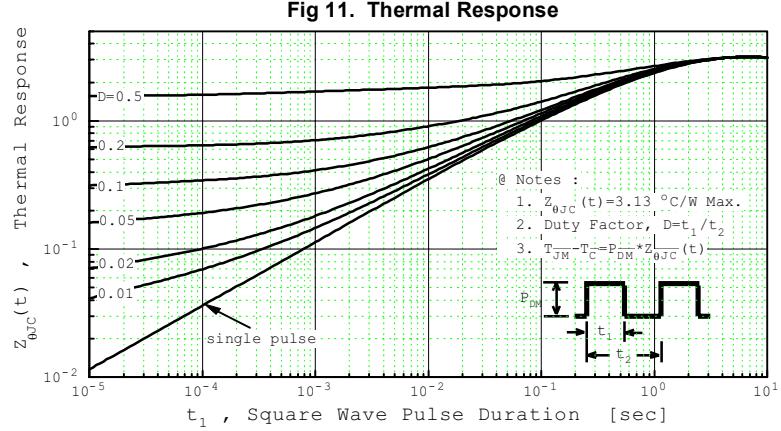
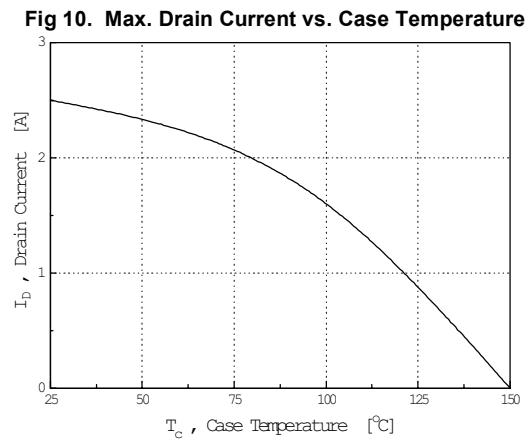
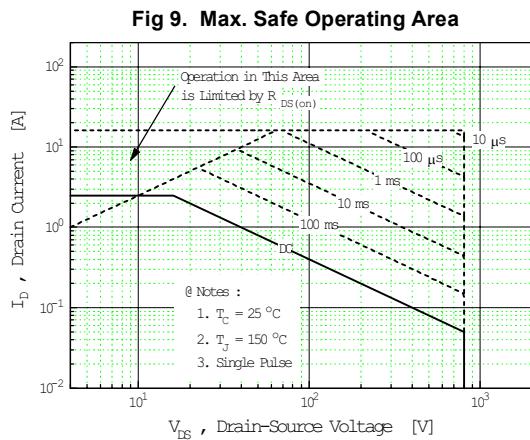
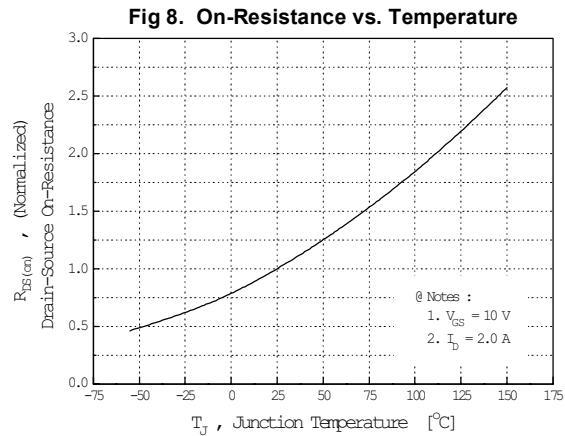
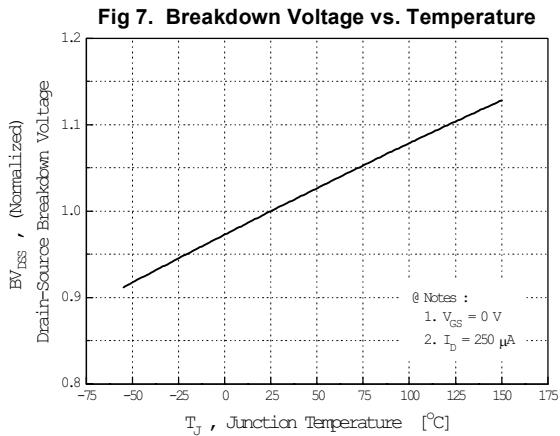


**Fig 6. Gate Charge vs. Gate-Source Voltage**



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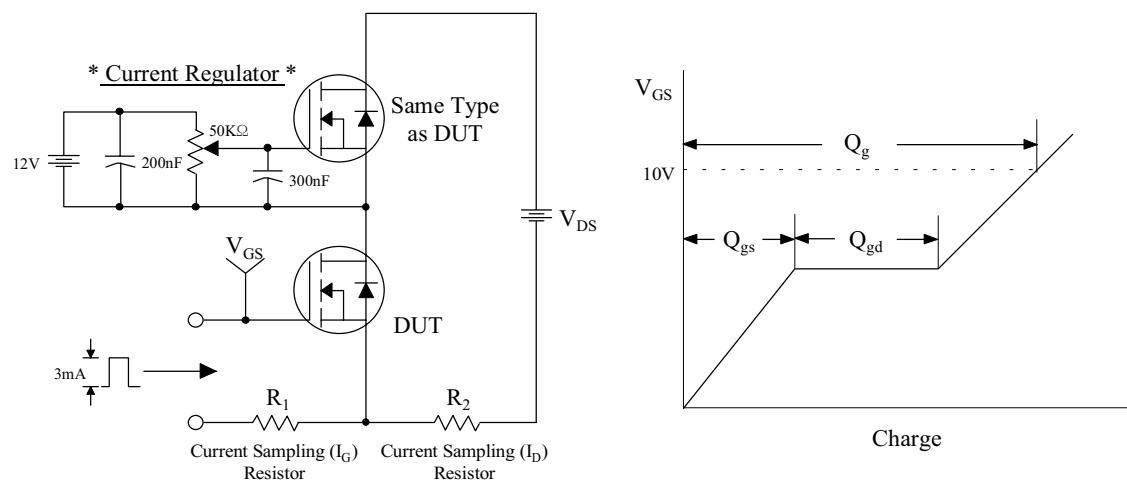
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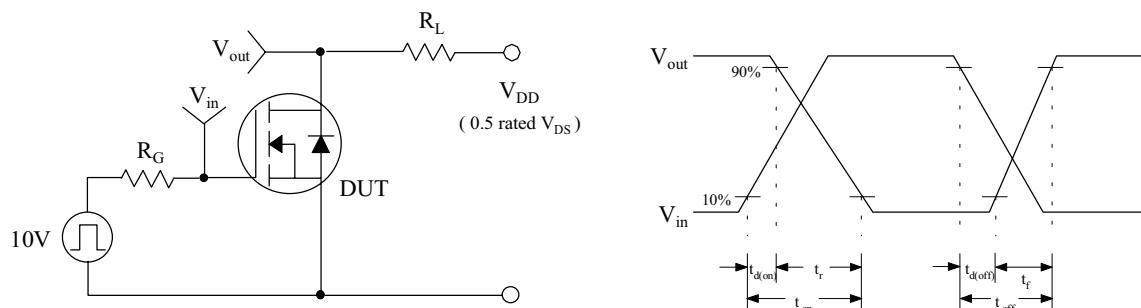
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**Fig 12. Gate Charge Test Circuit & Waveform**



**Fig 13. Resistive Switching Test Circuit & Waveforms**



**Fig 14. Unclamped Inductive Switching Test Circuit & Waveforms**

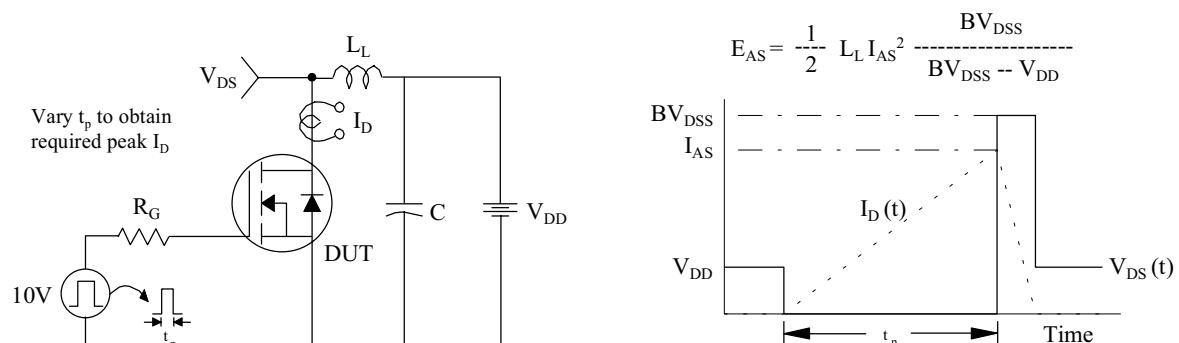


Fig 15. Peak Diode Recovery dv/dt Test Circuit & Waveforms

